

10 A Dual Schottky Barrier Rectifiers

DESCRIPTION

This UPS1040CTe3 in the Powermite3® package is a high efficiency centertap dual Schottky rectifier that is also RoHS compliant offering high current/power capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies. In addition to its size advantages, the Powermite3® package includes a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly and a unique locking tab act as an efficient heat path to the heat-sink mounting. Its innovative design makes this device ideal for use with automatic insertion equipment.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

KEY FEATURES

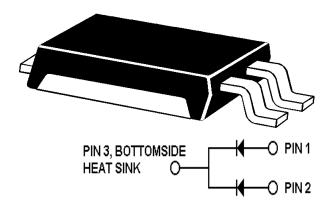
- Very low thermal resistance package
- Dual center-tap Schottky configuration with common cathode
- RoHS Compliant with e3 suffix part number
- Guard-ring-die construction for transient protection
- Efficient heat path with Integral locking bottom metal tab
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
- Compatible with automatic insertion
- Low profile-maximum height of 1mm

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

| Rating | Symbol | Value | Unit |
|---|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | $egin{array}{c} egin{array}{c} egin{array}{c} V_{RMM} \ V_{R} \end{array}$ | 40 | V |
| RMS Reverse Voltage | V _{R (RMS)} | 28 | V |
| Average Rectified Output Current | Io | 10 | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed on Rated Load@ T _c =90 °C | I _{FSM} | 150 | А |
| Storage Temperature | T_{STG} | -55 to +150 | °C |
| Junction Temperature | T_J | -55 to +125 | °C |

THERMAL CHARACTERISTICS (UNLESS OTHERWISE SPECIFIED)

| rnermai Resistance (duai device) | | | |
|----------------------------------|-----------------|-----|---------|
| Junctions-to Bottom (Case) | $R_{\theta JC}$ | 2.5 | °C/Watt |



APPLICATIONS/BENEFITS

- Switching and Regulating Power supplies.
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss with low I_{RM}
- Small foot print 190 X 260 mils (1:1 Actual size)
 See mounting pad details on pg 5

MECHANICAL & PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy compound meeting UL94V-0
- FINISH: Annealed matte-Tin plating over copper and readily solderable per MIL-STD-750 method 2026 (consult factory for Tin-Lead plating)
- POLARITY: See figure (left)
- MARKING: S1040CT•
- WEIGHT: 0.072 gram (approx.)
- · Package dimension on last page
- Tape & Reel option: 16 mm tape per Standard EIA-481-B, 5000 on 13" reel

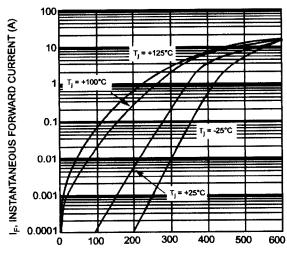


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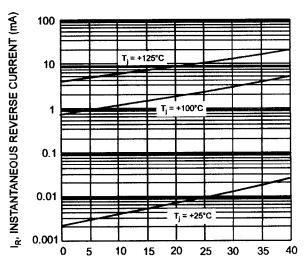
| Parameter | Symbol | Conditions | Min | Тур. | Max | Units |
|---------------------------------------|----------------|--|-----|------------------------------|------------------------------|----------------------|
| Forward Voltage (Note 1) Per Element | V _F | $I_F = 5 \text{ A}$, $T_J = 25 \text{ °C}$ $I_F = 5 \text{ A}$, $T_J = 100 \text{ °C}$ $I_F = 10 \text{ A}$, $T_J = 25 \text{ °C}$ $I_F = 10 \text{ A}$, $T_J = 100 \text{ °C}$ | | 0.44 0.39 0.51 0.50 | 0.48 0.42 0.57 0.55 | V |
| Reverse Breakdown Voltage (Note 1) | V_{BR} | I _R = 500 uA | 40 | | | V |
| Reverse Current (Note1) Per Element | I _R | V _R = 35V, T _j = 25 °C V _R = 35V, T _j = 100 °C V _R = 17.5V, T _j = 25 °C V _R = 17.5V, T _i = 100 °C | | 35 4 15 2 | 150 10 80 5 | uA mA uA mA |
| Capacitance Per Element | C _T | $V_R = 4 \text{ V}; f = 1 \text{ MH}_Z$ | | 375 | | pF |

Note: 1 Short duration test pulse used to minimize self-heating effect

GRAPHS



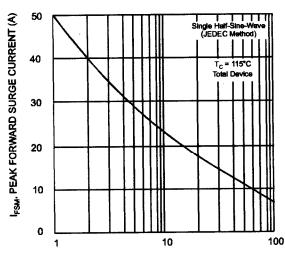
V_F, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 1 Typical Forward Characteristics, Per Element



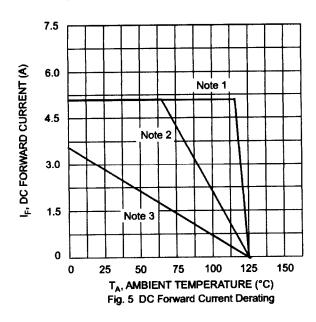
V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics, Per Element

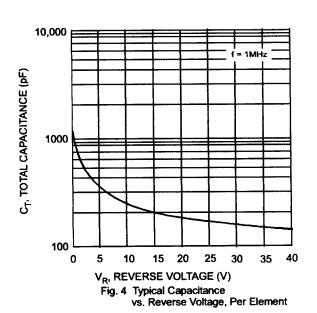


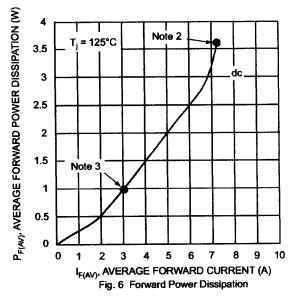
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NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Fwd Surge Current







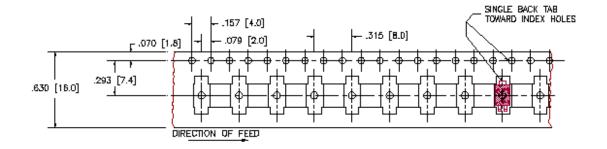
- NOTE 1: $T_A = T_C$ at case bottom where $R_{\theta JC} = 2.5^{\circ}$ C/W (dual device) and $R_{\theta CA} = 0^{\circ}$ C/W (infinite heat sink).
- NOTE 2: Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\theta JA}$ in range of 20-35° C/W.
- NOTE 3: Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout $R_{\theta JA}$ in range of 65°C/W. See mounting pad dimensions on page 5.



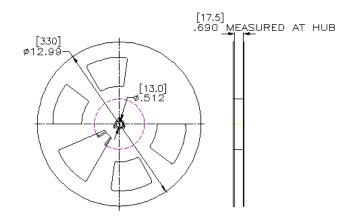
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TAPE & REEL

16 mm TAPE



13 INCH REEL



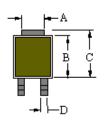


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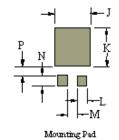
PACKAGE & PAD LAYOUT DIMENSIONS

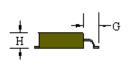
PACKAGING:

| | INCHES | MILLIMETERS |
|-----|---------|-------------|
| DIM | NOMINAL | NOMINAL |
| A | 0.070 | 1.778 |
| В | 0.173 | 4.392 |
| C | 0.200 | 5.080 |
| D | 0.035 | 0.889 |
| E | 0.160 | 4.064 |
| F | 0.072 | 1.829 |
| G | 0.056 | 1.422 |
| Н | 0.044 | 1.118 |
| J | 0.190 | 4.826 |
| K | 0.210 | 5.344 |
| L | 0.038 | 0.965 |
| M | 0.034 | 0.864 |
| N | 0.030 | 0.762 |
| P | 0.030 | 0.762 |











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| NOTES | Я |
|-------|---|
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